Application Number:	10567377			
Filing Date:	A METHOD OF ASSEMBLING A PACKAGED HIGH FREQUENCY CIRCUIT MODULE			
Title of Invention:				
First Named Inventor/Applicant Name:	Simon Leonard Rumer			
Filer:	Patrick C. Keane/mich sok			
Attorney Docket Number:	1033963-000020			
Filed as Large Entity				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:						
Pages:						
Claims:						
Miscellaneous-Filing:						
Petition:						
Patent-Appeals-and-Interference:						
Post-Allowance-and-Post-Issuance:						
Utility Appl issue fee	1501	1	1510	1510		
Publ. Fee- early, voluntary, or normal	1504	1	300	300		

Description	Fee Code	Quantity	Amount	Sub-Total i USD(\$)
Extension-of-Time:				
Miscellaneous:				
Printed copy of patent - no color	8001	1	3	3
	To	1813		